

ADQ32 Datasheet



The ADQ32 is a high-end 12-bit dual-channel data acquisition board optimized for use in high-throughput scientific applications. The ADQ32 features:

- One analog channel at 5 GSPS included
- Two analog channels at 2.5 GSPS per channel included
- Sampling rate option at 4 GSPS and 2 GSPS respectively
- 12 bits resolution
- 7 Gbyte/s sustained data transfer rate to GPU
- 7 Gbyte/s sustained data transfer rate to CPU
- Two external triggers
- General Purpose Input/Output (GPIO)
- Open FPGA for real-time signal processing
- Firmware option for averaging of records
- Firmware option for pulse analysis

The ADQ32 is available in a USB 3.2 format. See datasheet 25-3141 for details on the USB interface option.



1 ORDERING INFORMATION

ADQ32 is available with different front-end options. These options have separate datasheets. Select one front-end according to Table 1 and continue reading in the referenced datasheet.

Table 1 Analog front-end options

Order code	Description	Datasheet	User guide
ADQ32	DC-coupled front-end. This document.	20-2378	21-2539
ADQ32-PDRX	Built-in dual-gain front-end for pulse data. Use datasheet 22-2797.	22-2797	21-2539

ADQ32 is available with a set of options, see selections in Table 2.

Table 2 Ordering information for ADQ32

Order code	Description	Datasheet	User guide		
Clock rate option	s (select one)				
-S2G0	Clock rate base frequency is 2 GHz	20-2378	21-2539		
-S2G5	Clock rate base frequency is 2.5 GHz	20-2378	21-2539		
Analog bandwidt	h options (select one)				
-BW2G5	Analog bandwidth is 2.5 GHz	20-2378	21-2539		
-BW1G0	Analog bandwidth is 1 GHz	20-2378	21-2539		
Digital interface,	format (select one)				
-PCle	PCIe single slot card with PCIe Gen3x8 interface	20-2378	21-2539		
-USB	Stand-alone box with USB 3.2 connection. See	20-2378	21-2539		
	datasheet 25-3141 for additional information.	25-3141			
Firmware options	(Select any combination)				
-FWDAQ	Included data acquisition firmware.	20-2378	21-2539		
-FWATD	Firmware advanced time domain. Add thresholding	22-2912	21-2539		
	and waveform averaging in FPGA.				
-FWPD	Firmware pulse detection. Detect and analyze	23-3028	21-2539		
	pulses in FPGA.				
-FWOCT	Firmware for Swept-Source OCT signal conditioning.	23-3019	23-3000		
Additional features (Select any combination)					
-DEVDAQ ¹	Open FPGA for FWDAQ		20-2507		
-W5Y	Extended warranty 5 years				
-LICPDRX ²	Enable channel combination firmware		21-2539		

¹ The development kit **DEVDAQ** opens the FPGA for the user to add custom functions. **DEVDAQ** is a one-time purchase. The FPGA bit files built from the design project using **DEVDAQ** can be used on any ADQ32 with a valid **FWDAQ** license.

² The ADQ32 can be used with external dual-gain amplifier and channel combination in firmware. The option LICPDRX activates the channel combination for external dual-gain amplifier.



2 ADQ32 INTRODUCTION

2.1 Features

- One and two analog input channels
- 5 and 2.5 GSPS sampling rate per channel
- 12 bits resolution
- DC-coupled with 1 GHz bandwidth (optional 2.5 GHz)
- Programmable DC offset
- Internal and external clock reference
- Internal and external sampling clock
- Clock reference output
- Internal and external triggers
- 8 Gbyte data memory
- 7 Gbyte/s sustained data streaming to CPU and GPU
- Data interface PCIe Gen3 x8
- Averaging firmware FWATD
- Pulse analysis firmware FWPD
- Firmware for SS-OCT k-space re-mapping and signal conditioning

2.2 Applications

- Swept-Source Optical Coherence Tomography (SS-OCT)
- Time-of-flight mass spectrometry
- Distributed Optical Fiber Sensing
- LIDAR
- Scientific instruments
- Scanning acoustic microscopy

2.3 Advantages

- A compact high-performance digitizer that optimizes the system solution
- Real-time processing and high data throughput
- Teledyne SP Devices' design services are available for fast integration to reduce time-tomarket



2.4 System design optimization; open FPGA and streaming to CPU and GPU

High-performance data acquisition systems require high-speed real-time analysis. ADQ32 offers a variety of options for efficient system design:

Streaming to GPU

ADQ32 supports up to 7 Gbyte/s peer-to-peer streaming and streaming via pinned buffer to GPU. A GPU offers a powerful platform for implementing application-specific signal processing algorithms.

Streaming to CPU

ADQ32 supports up to 7 Gbyte/s to host computer. Implementing the application-specific algorithms in the CPU results in an efficient system.

Open FPGA for real-time processing

ADQ32 offers an open FPGA for implementation of the application-specific computations in the FPGA. This gives the most compact system design. Firmware development kit is ordered separately.

Pulse data recording

The hardware option ADQ32-PDRX offers a built-in dual-gain amplifier for pulse data capture with extended dynamic range. See datasheet 22-2797 for more details on the option ADQ32-PDRX.

3 TECHNICAL DATA

Technical parameters are valid for ADQ32 operating with firmware FWDAQ. All parameters are typical unless otherwise noted.



Table 3 Analog input (front panel label A and B) standard bandwidth 1 GHz

Parameter	Condition	Min	Typical	Max	Unit
Basic parameters					
Number of channels	2-channel mode		2		
Sampling rate per channel	2-channel mode	See table Ta	able 5		
Number of channels	1-channel mode		1		
Sampling rate	1-channel mode	See table Ta	able 5		
Bandwidth, -3dB	Default config.		1		GHz
Input range			0.5		Vpp
Input impedance			50		Ω
Coupling			DC		
Connector type		SMA			
Programmable DC-offset					
DC-offset range		-0.25		+0.25	V
Dynamic performance 2 chan	nels mode				
Cross talk	< 1 GHz		-70		dBFS
Noise power density	0 to 1.25 GHz		-148		dBFS/√Hz
SNR	260 MHz, -1dBFS		55		dBc
SFDR	260 MHz, -1dBFS		66		dBc
ENOB relative full scale	10 MHz, -1dBFS		9		bits
ENOB relative full scale	260 MHz, -1dBFS		8.9		bits
ENOB relative full scale	810 MHz, -1dBFS		8.5		bits
Dynamic performance, 1 char	nnels mode, no FIR	filter, connec	ctor A ³		
SNR	260 MHz, -1dBFS		54		dBc
SFDR	260 MHz, -1dBFS		65		dBc
ENOB relative full scale	10 MHz, -1dBFS		8.9		bits
ENOB relative full scale	260 MHz, -1dBFS		8.8		bits
ENOB relative full scale	810 MHz, -1dBFS		8.5		bits
Dynamic performance, 1 char	nnels mode, FIR filte	er ⁴ , connecto	or A ³		
SNR	260 MHz, -1dBFS		57		dBc
ENOB relative full scale	10 MHz, -1dBFS		9.2		bits
ENOB relative full scale	260 MHz, -1dBFS		9.2		bits
ENOB relative full scale	810 MHz, -1dBFS		9.1		bits

³ Performance parameters are valid for 1 channel mode using input A. There are no parameters available for 1 channel mode using input connector B.

⁴ Built-in user-programmable digital FIR filter; symmetrical, 17 taps. Filter coefficients used for this test are $[57, 92, -279, 21, 704, -720, -1163, 4127, 10784] / 2^{14}$.



Table 4 Analog input (front panel A and B) bandwidth option -BW2G55

Parameter	Condition	Min	Typical	Max	Unit
Basic parameters					
Number of channels	2 channels mode		2		
Sampling rate per channel	2 channels mode	See table Table 5			
Number of channels	1 channel mode		1		
Sampling rate	1 channel mode	See table Ta	ble 5		
Bandwidth -3dB	Option -BW2G5		2.5		GHz
Input range			0.5		Vpp
Input impedance			50		Ω
Coupling			DC		
Connector type			SMA		
Programmable DC-offset					
DC-offset range		-0.25		+0.25	V
Dynamic performance 2 chann	nels mode, option -	BW2G5			
Cross talk	< 1 GHz		-70		dBFS
Noise power density	0 to 1.25 GHz		-147		dBFS/√Hz
SNR	260 MHz, -1dBFS		54		dBc
SFDR	260 MHz, -1dBFS		63		dBc
ENOB relative full scale	10 MHz, -1dBFS		8.8		bits
ENOB relative full scale	260 MHz, -1dBFS		8.8		bits
ENOB relative full scale	810 MHz, -1dBFS		8.6		bits
Dynamic performance, 2 chan	nels mode, FIR filte	er ⁶ , option -B	W2G5		
ENOB relative full scale	260 MHz, -1dBFS	bits	9.2		bits
Dynamic performance, 1 chan	nel mode, no FIR fi	Iter, option -	BW2G5, con	nector A ⁷	
Noise power density	0 to 2.5 GHz		-150		dBFS/√Hz
SNR	260 MHz, -1dBFS		54		dBc
SFDR	260 MHz, -1dBFS		65		dBc
ENOB relative full scale	10 MHz, -1dBFS		8.8		bits
ENOB relative full scale	260 MHz, -1dBFS		8.8		bits
ENOB relative full scale	1625MHz,-1dBFS		8.3		bits
Dynamic performance, 1 chan	nel mode, FIR filter	^{6,} option -BV	V2G5, conne	ctor A ⁷	
ENOB relative full scale	810 MHz, -1dBFS		9.1		bits

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⁵ The analog bandwidth option -BW2G5 is factory installed and cannot be altered via software.

 $^{^6}$ Built-in user-programmable digital FIR filter; symmetrical, 17 taps. Filter coefficients used for this test are $[57, 92, -279, 21, 704, -720, -1163, 4127, 10784] / 2^{14}$.

⁷ Performance parameters are valid for 1 channel mode using input A. There are no parameters available for 1 channel mode using input connector B.



Table 5 Clock generator and front panel CLK connector.

Parameter	Condition	Min	Typical	Max	Unit			
Internal clock reference								
Frequency			10		MHz			
Accuracy			±3		ppm			
			±1/year					
Internal sampling clock gener	ator -S2G5 (standa	r d) ⁸						
Frequency range 1	2 channels	2440	2500	2500 ⁹	MHz			
Frequency range 2	2 channels	1840		1970	MHz			
Frequency range 1	1 channel	4880	5000	5000	MHz			
Frequency range 2	1 channel	3680		3940	MHz			
Internal sampling clock gener	ator option -S2G0 ⁸	1						
Frequency range 1	2 channels	1930	2000	2075	MHz			
Frequency range 2	2 channels	1460		1540	MHz			
Frequency range 1	1 channel	3860	4000	4150	MHz			
Frequency range 2	1 channel	2920		3080	MHz			
External clock reference input	(from front panel	CLK connecto	or) ¹⁰					
Frequency		1	10	500	MHz			
Frequency ¹¹	Jitter cleaner	10	10	500	MHz			
	enabled	-10 ppm		+10 ppm				
Frequency	Delay line used		10	100	MHz			
Delay line tuning range			500		ps			
Signal level		0.5		3.3	Vpp			
Input impedance	AC		50		Ω			
Input impedance	DC		10k		Ω			
Input impedance (high) 12	AC		200		Ω			
Clock reference output (on fro	ont panel CLK conn	ector) ¹³						
Frequency			10		MHz			
Signal level	Into 50-Ω load		1.2		Vpp			
Output impedance	AC		50		Ω			
Output impedance	DC		10k		Ω			

⁸ The internal clock generator can generate frequencies in 2 different ranges.

⁹ The software setting limit. The tolerance with external clock reference is up to 2505 MHz.

¹⁰ Using a clock reference from an external source to synchronize the ADQ32 to the external source.

 $^{^{11}}$ The jitter cleaner requires the reference frequency to be a multiple of 10 MHz within \pm 10ppm.

¹² Software-selectable high-impedance mode.

¹³ The internal clock reference of the ADQ32 is made available to synchronize external equipment.





Parameter	Condition	Min	Typical	Max	Unit			
External direct sampling clock input (from front panel CLK connector) ¹⁴								
Frequency 15		1000		2505	MHz			
Signal level		0.5		3.3	Vpp			
Impedance	AC		50		Ω			
Impedance	DC		10k		Ω			
Physical connector label CLK								
Connector type		SMA						

 $^{\rm 14}$ Using an external clock while bypassing the internal clock generator.

¹⁵ In single-channel mode, the sampling frequency is 2 times the external clock frequency.



Table 6 Front panel TRIG connector

Parameter	Condition	Min	Typical	Max	Unit			
Connector type		SMA						
Used as input (or GPIO)	Used as input (or GPIO)							
Impedance	DC		50		Ω			
Impedance (high) 16	DC		500		Ω			
Signal level	50-Ω mode	-0.5		3.3	V			
Adjustable threshold	50-Ω mode	0		2.8	V			
Signal level	High impedance	-0.5		5.5	V			
Adjustable threshold	High impedance	0		2.3	V			
Pulse repetition frequency	As trigger			10	MHz			
Time resolution 17	As trigger		50		ps			
Update rate ¹⁷	As GPIO			156.25	MHz			
Used as output (or GPIO)								
Impedance	DC		50		Ω			
Output level high VOH	Into 50-Ω load	1.8			V			
Output level low VOL	Into 50-Ω load			0.1	V			
Pulse repetition frequency				156.25	MHz			

Table 7 Front panel SYNC connector (may be used as a trigger source with larger timing grid)

Parameter	Condition	Min	Typical	Max	Unit
Connector type		SMA			
Used as input (or GPIO)					
Impedance	DC		50		Ω
Impedance (high) 16	DC		500		Ω
Signal range	50-Ω mode	-0.5		3.3	V
Adjustable threshold	50-Ω mode	0		2.8	V
Signal level	High impedance	-0.5		5.5	V
Adjustable threshold	High impedance	0		2.3	V
Pulse repetition frequency	As trigger			10	MHz
Time resolution 17	As trigger		3.2		ns
Update rate ¹⁷	As GPIO			156.25	MHz
Used as output (or GPIO)					
Impedance	DC		50		Ω
Output level high VOH	Into 50-Ω load	1.8			V
Output level low VOL	Into 50-Ω load			0.1	V
Pulse repetition frequency				156.25	MHz

¹⁶ Software-selectable high-impedance mode.

 $^{^{17}}$ Timing properties are valid for 2.5 GSPS in 2 channel mode and 5 GSPS in 1 channel mode. Timing properties scale linearly with sampling frequency.



Table 8 Front panel GPIO connector

Parameter	Condition	Min	Typical	Max	Unit
Connector type		SMA			
Used as input					
Impedance			50		Ω
Impedance (high) 16			10		kΩ
Input level high VIH		2			V
Input level low VIL				0.8	V
Update rate ¹⁷				156.25	MHz
Used as output					·
Output Impedance			50		Ω
Output level high VOH	Into 50-Ω load	1.5			V
Output level high VOH	No load	3.2			V
Output level low VOL	Into 50-Ω load			0.1	V
Output level low VOL	No load			0.1	V
Update rate ¹⁷				156.25	MHz

Table 9 Environment and mechanical parameters

Parameter	Condition	Min	Typical	Max	Unit			
Power and temperature								
Power consumption 18	FWDAQ		30		W			
Power supply		10.8	12	13.2	V			
Operating temperature	FWDAQ ¹⁹	0		55	°C			
Operating temperature	FW options ²⁰	0		45	°C			
Size								
Width			1		slot			
Length			225.7		mm			
Height			111.2		mm			
Compliances	Compliances							
RoHS3		Yes						
CE		Yes						
FCC	Exclusion according to CFR 47, part 15, paragraph 15.103(c).							

¹⁸ Power consumption depends on firmware option and use case. Power consumption is measured during acquisition and streaming of data at 5 Gbyte/s to PC.

¹⁹ Operating the ADQ32 with FWDAQ and streaming data up to 7 GBPS.

²⁰ Using firmware options from Teledyne SP Devices. Custom firmware designs may result in higher power consumption and thereby lower temperature range.

Table 10 Custom GPIO expansion. See section 10.

Parameter	Value			
Connector type	40-pin FFC/FPC connector, pitch 0.5 mm			
Number of differential IO signals LVDS	8			
Number of single-ended IO signals 3.3V	5			

Table 11 Data acquisition

Parameter	Condition	Min	Typical	Max	Unit	
Rearm time ²¹				20	ns	
Acquisition memory	Shared by all channels		8		Gbyte	
(Data FIFO)						
Record length	2-channel mode in steps of 1	2		2 ³² -1	samples	
	1-channel mode in steps of 1	2		2 ³² -1	samples	
Pretrigger ²²	2-channel mode in steps of 8	0		16 360	samples	
	1-channel mode in steps of 16	0		16 336	samples	
Trigger delay ²³	2-channel mode in steps of 8	0		2 ³⁵ -8	samples	
	1-channel mode in steps of 16	0		2 ³⁶ -16	samples	
Trigger sources ²⁴	Start recording a set of data	External	"TRIG", "SY	NC" and "G	SPIO"	
		Logic OR	of external	al sources		
		Channel				
		Logic OR	of channels	s		
		Internal generators				
		Software				
Recording modes	Record length setting	Static (se	t by user)			
		Dynamic	(data contr	olled)		
		Gated (tr	igger contr	olled)		
		Continuous (unlimited)				
Timestamp reset	Reset or synchronize	External "TRIG", "SYNC" and "GPIO"				
	timestamp	Software				
		Internal _I	periodic pu	lse generat	or	

²¹ Minimum time from the last sample of a record to the next trigger.

²² Pre-trigger is set by assigning the parameter "horizontal offset" a negative value

²³ Trigger delay is set by assigning the parameter "horizontal offset" a positive value

²⁴ Trigger sources can be synchronized to clock reference for synchronous systems

Table 12 Data transfer²⁵

Parameter	Value	Unit
Supported versions of data transfer standard PCIe	Gen1 / Gen2 / Gen3	
Supported number of lanes ²⁶	1/4/8	
Data rate to GPU / CPU sustained with headers	5	Gbyte/s
Data rate to GPU / CPU sustained without headers	7	Gbyte/s

Table 13 Software support

Parameter	Value		
Operating system ²⁷	Windows / Linux		
GUI	Digitizer Studio		
Example code	C, Python		
API	C / C++		
High-level API	LabVIEW / MATLAB / C#		

 $^{^{25}}$ The parameters in this table represent the ADQ32 only. The system configuration including the PC may add other limitations.

²⁶ The ADQ32 must be installed in a 16 lanes slot or a slot with a connector with an open end.

²⁷ See 15-1494 Operating system support for a detailed listing of supported distributions.



FEATURES FOR DATA FLOW CONTROL, SYNCHRONIZATION AND PROCESSING

Table 14 Digital signal processing blocks

Object	Description	
Digital Baseline Stabilizer (DBS)	Track and adjust the baseline to target level	
Digital gain	Digital scaling of the signal	
Digital offset	Add digital offset to signal	
Digital FIR filter	User controlled 17 tap FIR filter	
Sample skip	Skip samples after filtering to adjust sampling rate	
PDRX	Channel Combination for external dual-gain amplifier,	
	requires -LICPDRX option.	

Table 15 Pattern generators

Object	Description	
Pattern generator	2 instances of general pattern generators	
Periodic pulse generator	4 instances of periodic pulse generator	

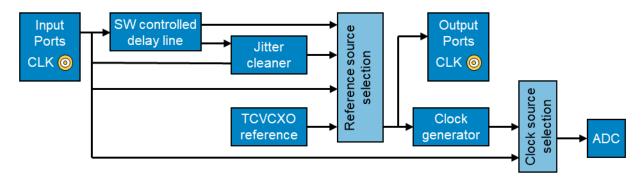


Figure 1 Clock generation block diagram.

Table 16 Clock generation

Function	Modes
Clock reference source	Internal
Phase and frequency reference for the	External
clock system.	External with jitter cleaner and/or delay line
Sampling clock sources	Internal clock generator
Actual clock for taking the samples of the	Direct external clock
analog data.	
Clock output	Selected clock reference

4 FIRMWARE

4.1 FWDAQ

The FWDAQ is included with all digitizers. The firmware includes control of the hardware and recording of data. The additional product DEVDAQ opens the FWDAQ for the user to insert custom signal processing.

The dual-gain channel combination included in FWDAQ requires a separate license for ADQ32.

4.2 FWATD

The FWATD is optional. It includes thresholding for noise suppression and accumulations of waveforms. See datasheet 22-2912 for more details.

The dual-gain channel combination included in FWATD requires a separate license for ADQ32.

4.3 FWPD

The FWPD is optional. It includes detection and analysis of pulses. See datasheet 23-3028 for more details.

The dual-gain channel combination is included in FWPD requires a separate license for ADQ32.

4.4 FWOCT

The FWOCT is an optional firmware for Swept-Source OCT. It includes k-space re-mapping, background compensation, dispersion compensation, windowing, FFT and log compression. See datasheet 23-3019 for more details.

4.5 Managing firmware

The digitizer supports multiple firmware images. Note the following about managing firmware images:

- The non-volatile memory on the digitizer can store up to four different firmware images (including the active firmware). Use the tool ADQAssist to change firmware and to upload new images to the digitizer.
- Each hardware can include a license for multiple firmware options. If all firmware images
 cannot be stored on the device, some may need be stored on the host computer for manual
 reprogramming via ADQAssist.
- The digitizer (and the enclosing host computer) must be power cycled for the firmware switch to be completed. This is required to let the PCIe bus enumerate with the new firmware.
- Some firmware features require a valid license key to activate. See the ordering information section for details about available firmware features.
- Switching mode between one channel at 5 GSPS and two channels at 2.5 GSPS requires switching the digitizer firmware image.



5 ABSLOUTE MAXIMUM RATINGS

Table 17 Absolute maximum ratings

Parameter	Condition	Min	Max	Unit
Power supply to GND		-0.4	14	V
Operating temperature ²⁸		0	55	°C
Storage temperature		-40	70	°C
Analog in to GND		-1.75	+1.75	V
TRIG to GND	50-Ω mode	-2	5	V
SYNC to GND	50-Ω mode	-2	5	V
TRIG to GND	500-Ω mode	-2	6	V
SYNC to GND	500-Ω mode	-2	6	V
CLK REF to GND AC amplitude			5	Vpp
CLK REF to GND DC-level		-5	5	V
GPIO to GND		-1.5	5	V
FFC / FPC differential signal to GND	Powered ²⁹	-0.5	2.3	V
	Not powered ²⁹	-0.5	0.5	V
FFC / FPC single-ended signal to GND	Powered ²⁹	-0.3	3.8	V
	Not powered ²⁹	-0.3	0.5	V

Exposure to conditions exceeding these ratings may reduce lifetime or permanently damage the digitizer. The digitizer with PCIe format has a built-in fan to cool the device. The built-in temperature monitoring unit will protect the digitizer from overheating by temporarily shutting down parts of the device in an overheat situation.

The SMA connectors have an expected lifetime of 500 operations. For frequent connecting and disconnecting of cables, connector savers are recommended.

 $^{^{\}rm 28}$ The absolute maximum temperature is the range where it is allowed to start the board.

²⁹ The absolute maximum ratings depend on whether the ADQ32 is powered or not. It is recommended to use the respective power rail in the FFC connector to power or enable the external drivers to avoid driving overvoltage into an unpowered digitizer. Use the 1.8 V rail for the differential signals and 3.3 V for the single-ended signals.

6 TYPICAL PERFORMANCE

6.1 Frequency response

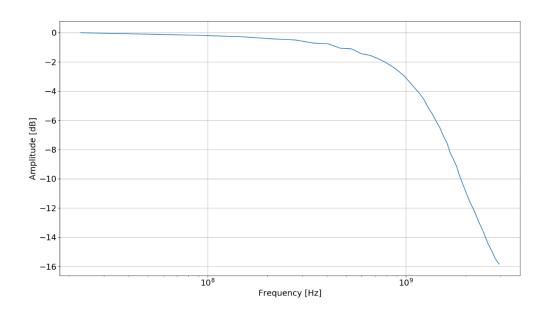


Figure 2 Frequency response, typical performance BW1G0.

6.2 FFT

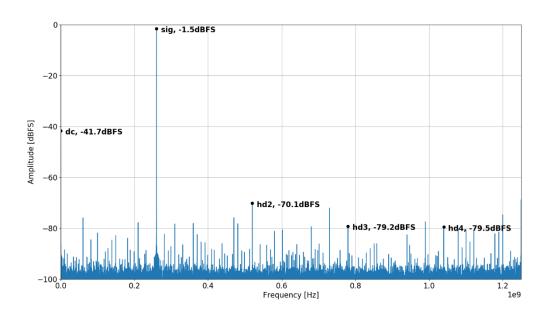


Figure 3 FFT typical performance 2.5 GSPS BW1G0.

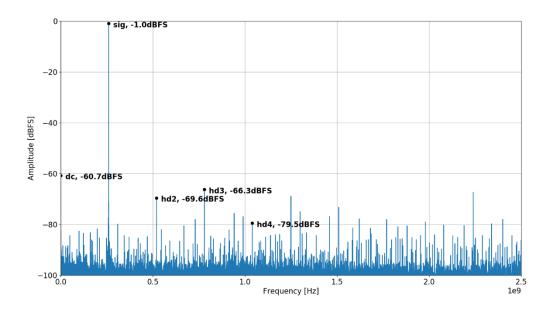


Figure 4 FFT typical performance at 5 GSPS, BW1G0

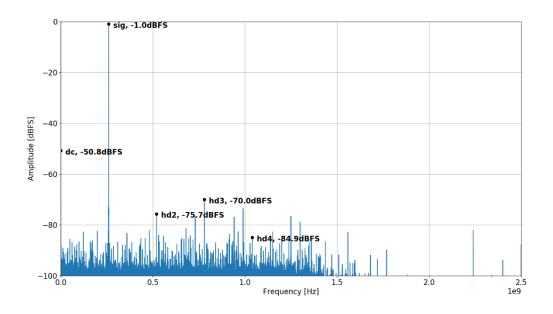


Figure 5 FFT typical performance 5 GSPS, using digital FIR filter, BW1G0.



7 TYPICAL PERFORMANCE BANDWIDTH OPTION -BW2G5

7.1 Frequency response

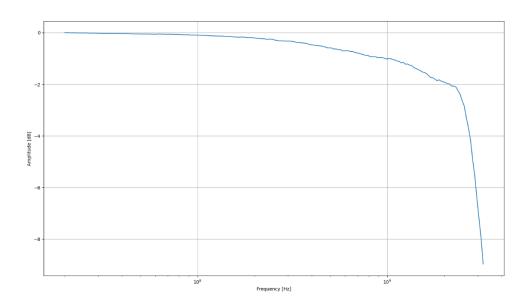


Figure 6 Frequency response, analog bandwidth option -BW2G5.

7.2 FFT

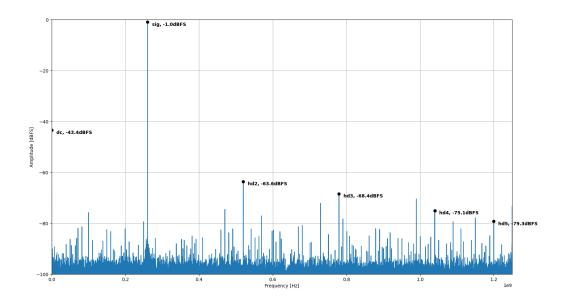


Figure 7 FFT typical performance 2.5 GSPS, analog bandwidth option -BW2G5.

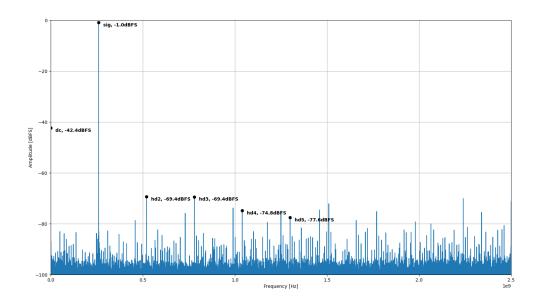


Figure 8 FFT typical performance at 5 GSPS, analog bandwidth option -BW2G5

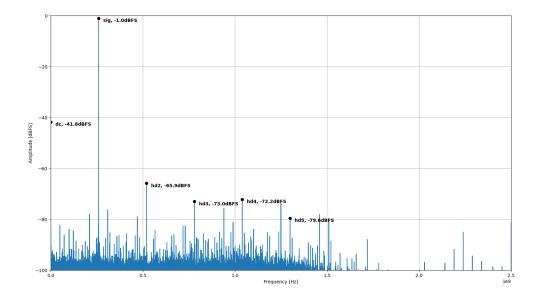


Figure 9 FFT typical performance 5 GSPS, using digital FIR filter, analog bandwidth option -BW2G5

8 BLOCK DIAGRAM

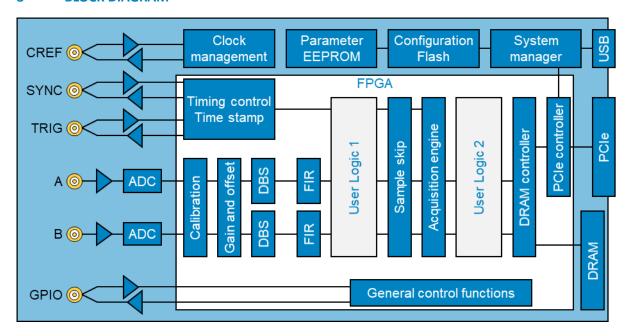


Figure 10 Block diagram.

Figure 10 shows a block diagram of ADQ32 in 2channels mode. The boxes "User Logic" are open for custom real-signal processing thought the firmware development kit (purchased separately).

9 HOST PC INTERFACE PCIE

The ADQ32-PCIe is powered from the power supply of the PC via a PCI Express 6-pin (2x3) auxiliary power supply connector. The connection in the cable should be as in Figure 11. A suitable connector is for example Molex 45559-0002. It is important that the auxiliary power supply is turned on immediately when the PC starts. Otherwise, the digitizer will not be recognized on the PCI Express bus.

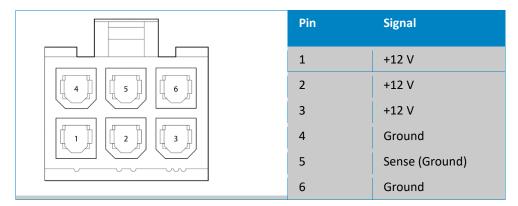


Figure 11 Power supply connection. Cable connector, looking into the connector end.

10 GPIO EXPANSION

The FCP connector allows direct access to the FPGA for building custom expansion boards. The FCP connector requires custom firmware and is accessible through the FPGA development kit. The ADQ32 user guide document number 21-2539 contains a description of connector.

Note that this connector is connected directly to the FPGA. Damage caused by custom hardware failure is not covered by warranty.

Contact Teledyne SP Devices' sales representative for more information.

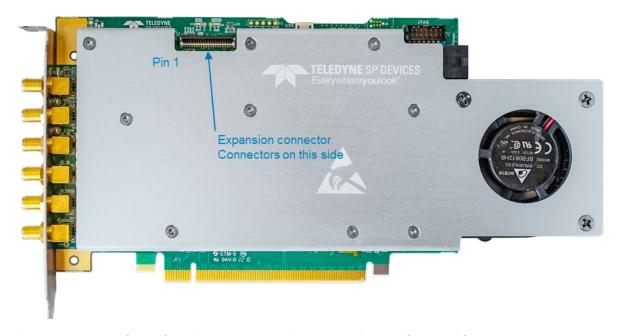


Figure 12 ADQ32 photo showing GPIO expansion connection on the top side.



11 MECHANICAL DRAWING

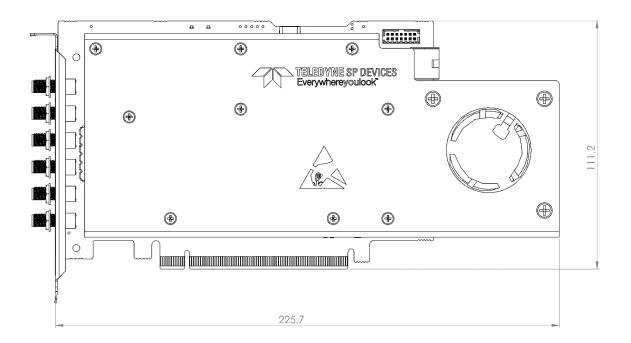


Figure 13 Mechanical drawing.

12 REFERENCES

Refer to TSPD's web site spdevices.com for the latest version of documents.

- 15-1494 Supported operating systems
- 18-2059 ADQUpdater user guide
- 20-2507 ADQ3 series development kit user guide
- 20-2521 ADQAssist user guide
- 21-2539 ADQ3 series user guide
- 22-2797 ADQ32-PDRX datasheet
- 22-2912 ADQ3 FWATD datasheet
- 23-3019 ADQ3 FWOCT datasheet
- 23-3028 ADQ3 FWPD datasheet
- 25-3141 ADQ3 USB datasheet



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